

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





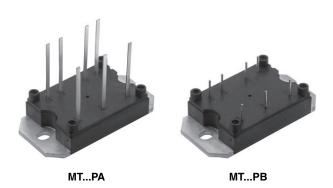




www.vishay.com

Vishay Semiconductors

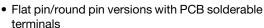
Three Phase Bridge (Power Modules), 45 A to 100 A



PRODUCT SUMMARY				
Io	45 A to 100 A			
V _{RRM}	1600 V			
Package	MTPA, MTPB			
Circuit	Three phase bridge			

FEATURES

- Low V_F
- Low profile package
- Direct mounting to heatsink



- COMPLIANT
- · Low junction to case thermal resistance
- 3500 V_{RMS} insulation voltage
- UL approved file E78996 **Tu** vie
- Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Power conversion machines
- Welding
- UPS
- SMPS
- Motor drives
- General purpose and heavy duty application

DESCRIPTION

A range of extremely compact three-phase rectifier bridges offering efficient and reliable operation. The low profile package has been specifically conceived to maximize space saving and optimize the electrical layout of the application specific power supplies.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES 40MT	VALUES 70MT	VALUES 100MT	UNITS	
1		45	75	100	Α	
I _O	T _C	100	80	80	°C	
	50 Hz	270	380	450	^	
I _{FSM}	60 Hz	280	398	470	Α	
I ² t	50 Hz	365	724	1013	A ² s	
1-1	60 Hz	325	660	920	A-s	
I ² √t		3650	7240	10 130	A ² √s	
V _{RRM}		<u>.</u>	1600		V	
T _{Stg}	Dange	-40 to 125			- °C	
T _J	Range		-40 to 150]	

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS								
TYPE NUMBER	VOLTAGE CODE REVERSE VOLTAGE V	V _{RRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK V	I _{RRM} MAXIMUM AT T _J = 150 °C mA				
VS-40MT160P, VS-70MT160P, VS-100MT160P	160	1600	1700	5				



www.vishay.com

Vishay Semiconductors

FORWARD CONDUCTION								
PARAMETER	SYMBOL		TEST CONDITIONS			VALUES 70MT	VALUES 100MT	UNITS
Maximum DC output		1000			45	75	100	А
current at case temperature	lo	120° rect. to	conduction angle		100	80	80	°C
		t = 10 ms	No voltage		270	380	450	
Maximum peak, one cycle	_	t = 8.3 ms	reapplied		280	398	470	A
state surge current	forward, non-repetitive on state surge current		225	320	380	A		
		t = 8.3 ms	reapplied	Initial	240	335	400	
		t = 10 ms	No voltage	$T_J = T_J$ maximum	365	724	1013	
Maximum I ² t for fusing	l ² t	t = 8.3 ms	reapplied		325	660	920	A ² s
Maximum I-t for fusing	1-1	t = 10 ms	100 % V _{RRM}		253	512	600	A-5
		t = 8.3 ms	reapplied		240	467	665	
Maximum I ² √t for fusing	I ² √t	t = 0.1 ms to	t = 0.1 ms to 10 ms, no voltage reapplied			7240	10 130	A²√s
Value of threshold voltage	V _{F(TO)}	T. mavimum	T _J maximum			0.82	0.75	V
Slope resistance	r _t	1 J III d XIII I I I I I				9.5	8.1	mΩ
Maximum forward voltage drop	V_{FM}		T_J = 25 °C; t_p = 400 μ s single junction (40MT, I_{pk} = 40 A) (70MT, I_{pk} = 70 A) (100MT, I_{pk} = 100 A)			1.45	1.51	V

INSULATION TABL	E					
PARAMETER	SYMBOL	TEST CONDITIONS	40MT	70MT	100MT	UNITS
RMS insulation voltage	V _{INS}	$T_J = 25$ °C, all terminal shorted, f = 50 Hz, t = 1 s		3500		V

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	40MT	70 M T	100MT	UNITS
Maximum junction operating temperature range	T _J			- 40 to 15	0	°C
Maximum storage temperature range	T _{Stg}			- 40 to 125		O
		DC operation per module	0.27	0.23	0.19	
Maximum thermal resistance,	R _{thJC}	DC operation per junction	1.6	1.38	1.14	
junction to case		120° rect. condunction angle per module	0.38	0.29	0.22	
		120° rect. condunction angle per junction	2.25	1.76	1.29	K/W
Maximum thermal resistance,case to heatsink per module	R _{thCS}	Mounting surface smooth, flat and greased Heatsink compound thermal conductivity = 0.42 W/mK		0.1		
Mounting torque to heatsink ± 10 %		A mounting compound is recommended and the torque should be rechecked after a	4			Nm
Approximate weight		period of 3 hours to allow for the spread of the compound. Lubricated threads		65		g

CLEARANCE AND CREEPAGE DISTANCES						
PARAMETER	TEST CONDITIONS	MTPA	MTPB	UNITS		
Clearance	External shortest distances in air between terminals which are not internally short circuited together	10.9 12.3		mm		
Creepage distance	Shortest distance along external surface of the insulating material between terminals which are not internally short circuited together	10.9 12.3		mm		

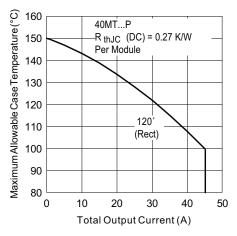


Fig. 1 - Current Rating Characteristics

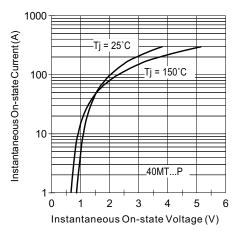


Fig. 2 - On-State Voltage Drop Chracteristics

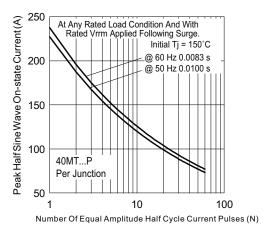


Fig. 3 - Maximum Non-Repetitive Surge Current

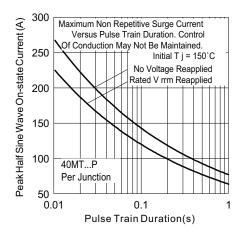


Fig. 4 - Maximum Non-Repetitive Surge Current

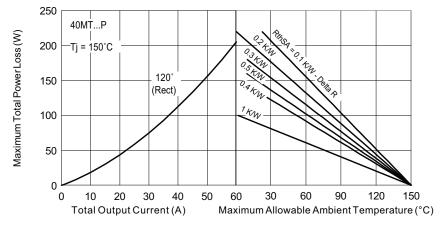


Fig. 5 - Current Rating Nomogram (1 Module Per Heatsink)

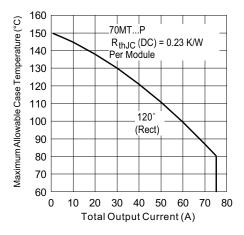


Fig. 6 - Current Rating Characteristics

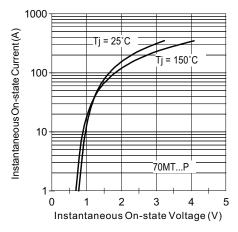


Fig. 7 - On-State Voltage Drop Characteristics

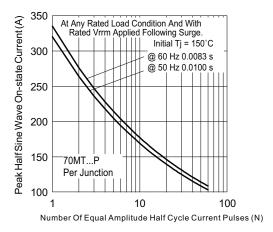


Fig. 8 - Maximum Non-Repetitive Surge Current

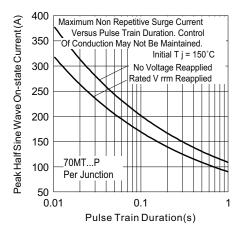


Fig. 9 - Maximum Non-Repetitive Surge Current

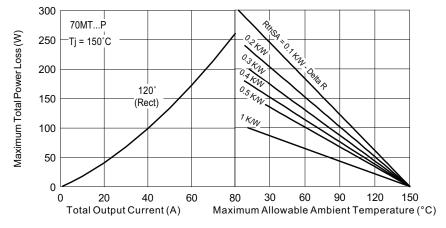


Fig. 10 - Current Rating Nomogram (1 Module Per Heatsink)

Vishay Semiconductors

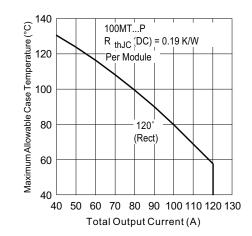


Fig. 11 - Current Rating Characteristics

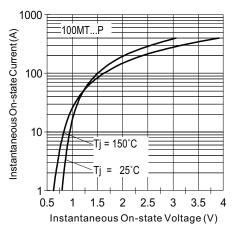


Fig. 12 - On-State Voltage Drop Characteristics

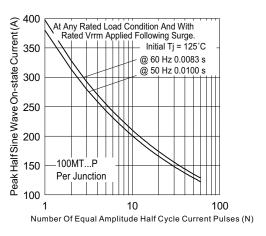


Fig. 13 - Maximum Non-Repetitive Surge Current

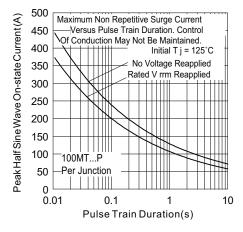


Fig. 14 - Maximum Non-Repetitive Surge Current

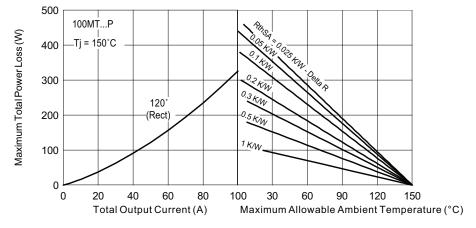


Fig. 15 - Current Rating Nomogram (1 Module Per Heatsink)

Vishay Semiconductors

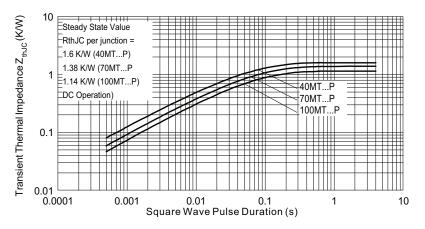
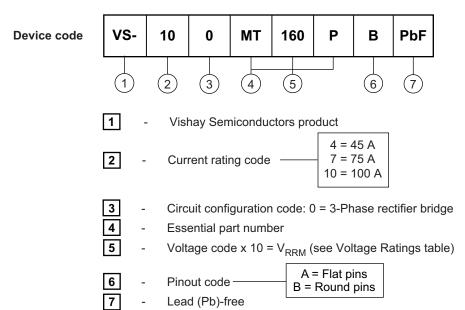
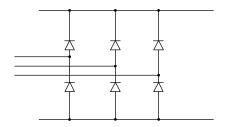


Fig. 16 - Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE



CIRCUIT CONFIGURATION



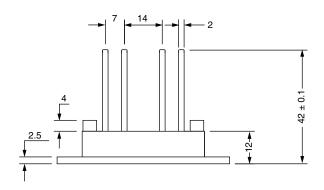
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95244			

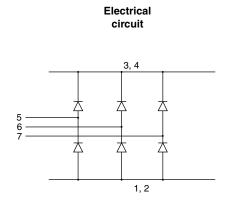


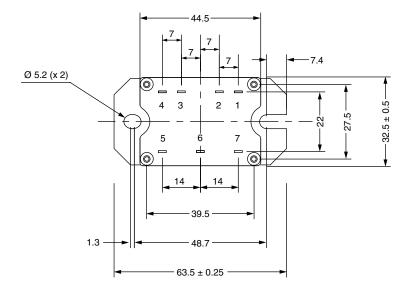
Vishay Semiconductors

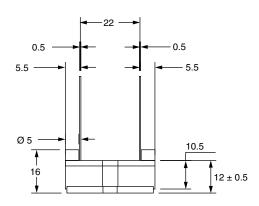
MTP Flat and Round Pin

DIMENSIONS FOR MTP WITH FLAT PIN in millimeters





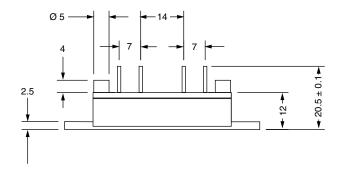


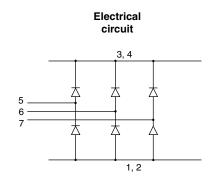


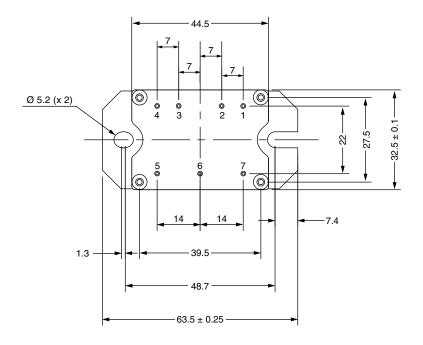
MTP Flat and Round Pin

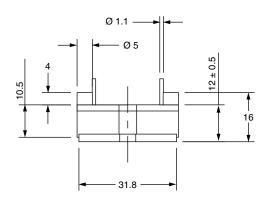


DIMENSIONS FOR MTP WITH ROUND PIN in millimeters









Document Number: 95244 Revision: 07-Nov-07



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.